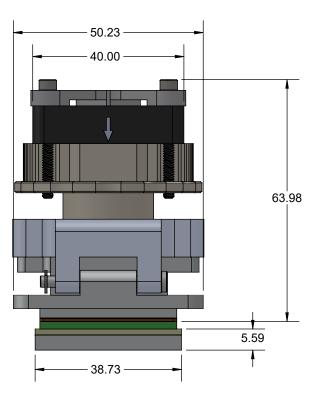
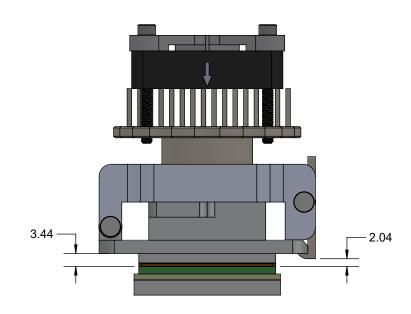
GHz BGA Socket - Direct mount, solderless

Features

- Directly mounts to target PCB (needs tooling holes) with hardware
 High speed, reliable Elastomer connection
- Minimum real estate required
- Compression plate distributes forces evenly

REQUIRED TORQUE: 14 IN-LB, 158 N-CM RECOMMENDED TORQUE DRIVER TL-TORQUEDRIVER-02



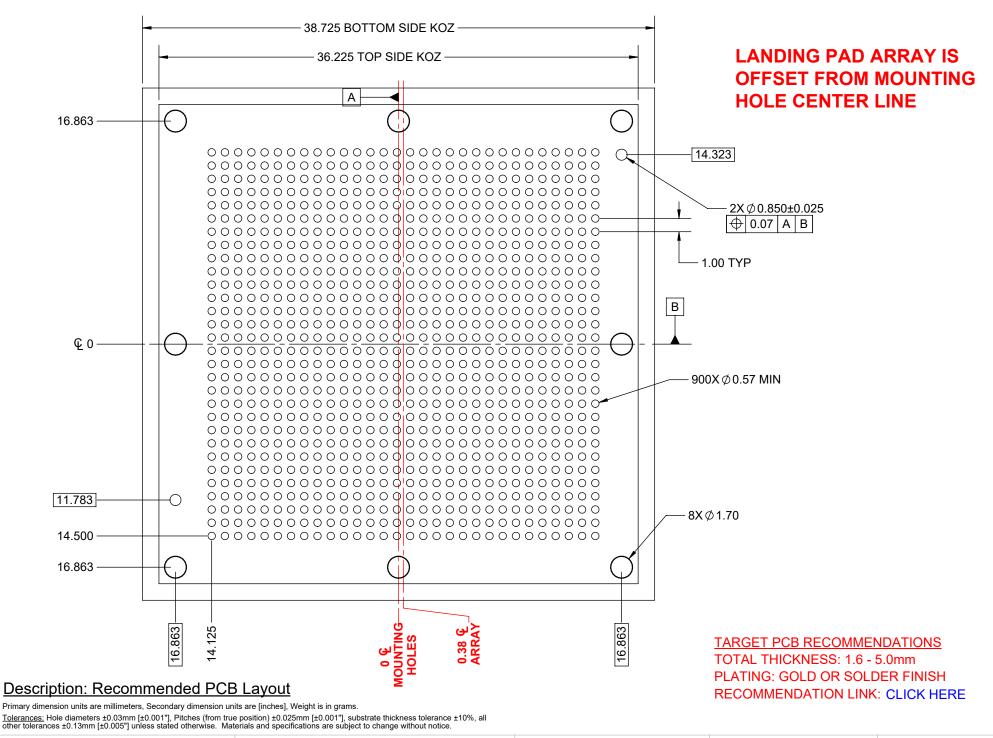


Description: M24 Heat Sink Assembly

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.0254mm [±0.001"], Pitches (from true position) ±0.0762mm [±0.003"], substrate thickness tolerance ±10%, all other tolerances ±0.127mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

CG-BGA-4027 Drawing	Finish: Weight: 227.23	STATUS: Released	SHEET: 1 OF 4	REV. A
©2019 Ironwood Electronics, Inc. Tele: (800) 404-0204		ENG: M. Raske	DRAWN BY: M. Raske	SCALE: 1:1
www.ironwoodelectronics.com		FILE: CG-BGA-4027 Dwg	DATE: 10/04/2019	



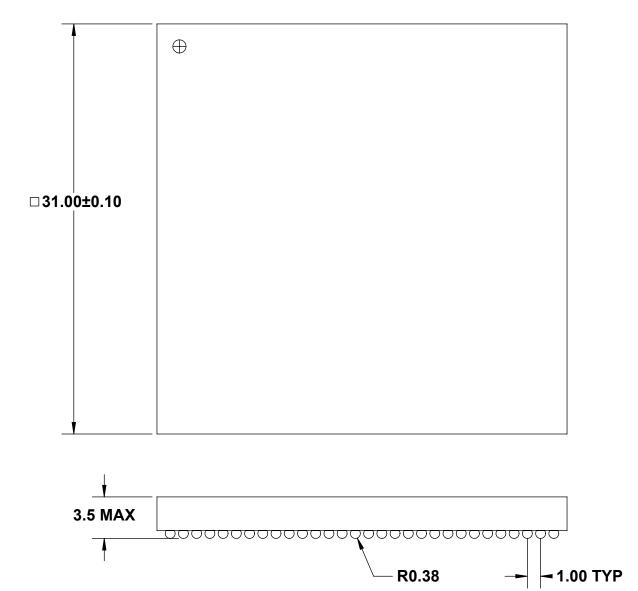
CG-BGA-4027 Drawing

©2019 Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com Material: Finish: Weight: 227.23
 STATUS: Released
 SHEET: 2 OF 4
 REV. A

 ENG: M. Raske
 DRAWN BY: M. Raske
 SCALE: 3.5:1

 FILE: CG-BGA-4027 Dwg
 DATE: 10/04/2019

IRONWOOD PACKAGE CODE: BGA900A



Dimensions are in millimeters.

- 1.
- Interpret dimensions and tolerances per ASME Y14.5M-1994.

 Dimension b is measured at the maximum solder ball diameter, parallel to datum plane Z. 2.
- 3.
- Datum Z (seating plane) is defined by the spherical crowns of the solder balls.

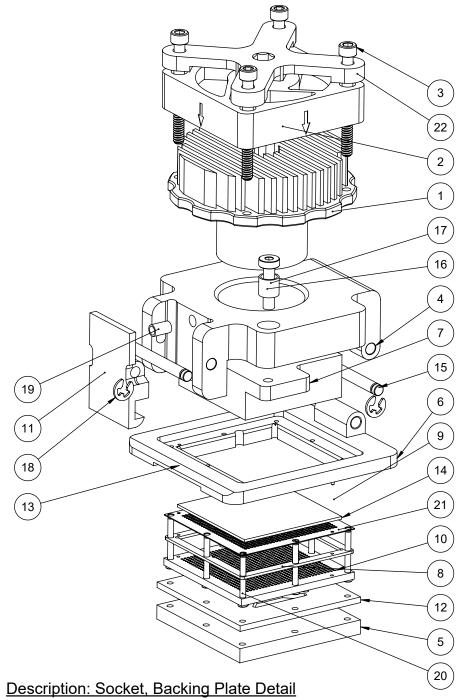
 Parallelism measurement shall exclude any effect of mark on top surface of package.

Description: Compatible Device

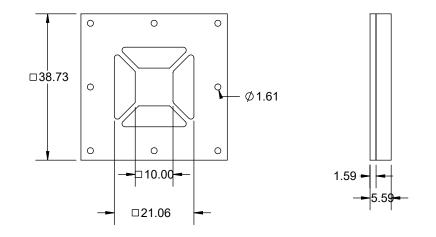
Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

	CG-BGA-4027 Drawing	Finish: Weight: 3.33	STATUS: Released	SHEET: 3 OF 4	REV. A
	©2019 Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com		ENG: M. Raske	DRAWN BY: M. Raske	SCALE: 3.5:1
			FILE: CG-BGA-4027 Dwg	DATE: 10/04/2019	



ITEM NO.	DESCRIPTION	QTY.
1	1 HEAT SINK COMPRESSION SCREW M24	
2	2 FAN 40X10MM 12VDC 1.6W 9.9CFM	
3	Socket Head Cap Screw, 4-40 x 1 1/18" long, SS	
4	4 CLAMSHELL SOCKET LID 35mm	
5	5 BACKING PLATE	
6	SOCKET BASE	1
7	COMPRESSION PLATE	1
8	ELASTOMER GUIDE 31mm IC	1
9	CUSTOMER's BGA IC	1
10	PCB BGA900 30X30 ARRAY 1mm	1
11	LATCH	1
12	INSULATION PLATE	1
13	DOWEL PIN, 1/32" X 3/16", SS	2
14	63 DEG ANGLED ELASTOMER	1
15	HINGE PIN STAINLESS STEEL	2
16	SCREW, M3 X 12mm, LOW HEAD CAP, SS	2
17	SPRING CLAMSHELL LID ASSEMBLY	2
18	RETAINING RING	2
19	COMPRESSION SPRING	1
20	#0-80 X 0.5, SH CAP SCREW	8
21	21 BALL GUIDE	
22	TORQUING BRACKET	1



Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

CG-BGA-4027 Drawing



©2019 Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com Material: Finish: Weight: 227.23

STATUS: Released	SHEET: 4 OF 4	REV. A
ENG: M. Raske	DRAWN BY: M. Raske	SCALE: 1:1
FILE: CG-BGA-4027 Dwg	DATE: 10/04/2019	